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Quad 2-Input NOR Gate MM74HC02

General Description The MM74HC02 NOR gates utilize advanced silicon–gate CMOS technology to achieve operating speeds similar to LS–TTL gates with the low power consumption of standard CMOS integrated circuits. All gates have buffered outputs, providing high noise immunity and the ability to drive 10 LS–TTL loads. The 74HC logic family is functionally as well as pin–out compatible with the standard 74LS logic family. All inputs are protected from damage due to static discharge by internal diode clamps to V_{CC} and ground.

Features

- Typical Propagation Delay: 8 ns
- Wide Power Supply Range: 2 V to 6 V
- Low Quiescent Supply Current: 20 µA Maximum (74HC Series)
- Moisture Level Sensitivity 1
- Low Input Current: 1 µA Maximum
- High Output Current: 4 mA Minimum
- This Device is Pb–Free and Halide Free

ABSOLUTE MAXIMUM RATINGS (Note 1)

Symbol	Parameter	Rating	Unit
V _{CC}	Supply Voltage	-0.5 to +6.5	V
V _{IN}	DC Input Voltage	–0.5 to V _{CC} +0.5	V
V _{OUT}	DC Output Voltage	–0.5 to V _{CC} +0.5	V
I _{IK} , I _{OK}	Clamp Diode Current	±20	mA
I _{OUT}	DC Output Current, per pin	±25	mA
Icc	DC V_{CC} or GND Current, per pin	±50	mA
T _{STG}	Storage Temperature Range	-65 to +150	°C
P _D	Power Dissipation SOIC TSSOP	1077 833	mW
TL	Lead Temperature (Soldering 10 seconds)	260	°C

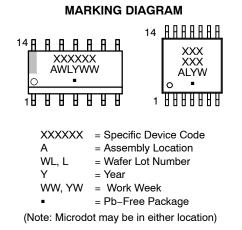
Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

1. Unless otherwise specified all voltages are referenced to ground.



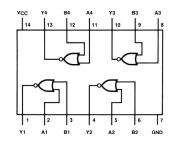
SOIC-14 NB, CASE 751A

TSSOP-14, CASE 948G

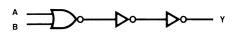


CONNECTION DIAGRAM

Pin Assignment for SOIC and TSSOP



LOGIC DIAGRAM



ORDERING INFORMATION

See detailed ordering and shipping information on page 3 of this data sheet.

MM74HC02

RECOMMENDED OPERATING CONDITIONS

Symbol	Parameter	Min	Max	Unit	
V _{CC}	Supply Voltage	2	6	V	
V _{IN} , V _{OUT}	DC Input or Output Voltage	0	V _{CC}	V	
T _A	Operating Temperature Range	-40	+85	°C	
t _r , t _f	Input Rise or Fall Times V _{CC} = 2.0 V		-	1000	ns
	V _{CC} = 4.5 V		-	500	
		V _{CC} = 6.0 V	-	400	1

Functional operation above the stresses listed in the Recommended Operating Ranges is not implied. Extended exposure to stresses beyond the Recommended Operating Ranges limits may affect device reliability.

DC ELECTRICAL CHARACTERISTICS (Note 2)

				T _A =	25°C	T _A = −40°C to 85°C	T _A = −55°C to 125°C	
Symbol	Parameter	V _{CC} (V)	Conditions	Тур.		Guaranteed I	imits	Unit
V _{IH}	Minimum HIGH Level	2.0		-	1.50	1.50	1.50	V
	Input Voltage	4.5		-	3.15	3.15	3.15	
		6.0		-	4.20	4.20	4.20	
V _{IL}	Maximum LOW Level	2.0		-	0.50	0.50	0.50	V
	Input Voltage	4.5		-	1.35	1.35	1.35	
		6.0		-	1.80	1.80	1.80	
V _{OH}	Minimum HIGH Level	2.0	$V_{IN} = V_{IH} \text{ or } V_{IL},$	2.0	1.9	1.9	1.9	V
Output Voltage	Output Voltage	4.5	- Î _{OUT} ≦ 20 μÂ	4.5	4.4	4.4	4.4	-
		6.0		6.0	5.9	5.9	5.9	
		4.5	$V_{IN} = V_{IH} \text{ or } V_{IL},$ $ I_{OUT} \le 4.0 \text{ mA}$	4.20	3.98	3.84	3.70	
		6.0	$V_{IN} = V_{IH} \text{ or } V_{IL},$ $ I_{OUT} \le 5.2 \text{ mA}$	5.70	5.48	5.34	5.20	
V _{OL} Maximum LOW Level		2.0	$V_{IN} = V_{IH} \text{ or } V_{IL}$	0	0.1	0.1	0.1	V
	Output Voltage	4.5	I _{OUT} ≤ 20 μA	0	0.1	0.1	0.1	
		6.0		0	0.1	0.1	0.1	
		4.5	$V_{IN} = V_{IH} \text{ or } V_{IL}$ $ I_{OUT} \le 4.0 \text{ mA}$	0.20	0.26	0.33	0.40	
		6.0	$V_{IN} = V_{IH} \text{ or } V_{IL}$ $ I_{OUT} \le 5.2 \text{ mA}$	0.20	0.26	0.33	0.40	
I _{IN}	Maximum Input Current	6.0	$V_{IN} = V_{CC}$ or GND	-	±0.1	±1.0	±1.0	μA
I _{CC}	Maximum Quiescent Supply Current	6.0	V_{IN} = V_{CC} or GND, I_{OUT} = 0 μ A	-	2.0	20	40	μΑ

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

2. For a power supply of 5 V ±10% the worst case output voltages (V_{OH}, and V_{OL}) occur for HC at 4.5 V. Thus the 4.5 V values should be used when designing with this supply. Worst case V_{IH} and V_{IL} occur at V_{CC} = 5.5 V and 4.5 V respectively. (The V_{IH} value at 5.5 V is 3.85 V.) The worst case leakage current (I_{IN}, I_{CC}, and I_{OZ}) occur for CMOS at the higher voltage and so the 6.0 V values should be used.

AC ELECTRICAL CHARACTERISTICS

 $(V_{CC} = 5 \text{ V}, \text{ } \text{T}_{\text{A}} = 25^{\circ}\text{C}, \text{ } \text{C}_{\text{L}} = 15 \text{ pF}, \text{ } \text{t}_{\text{r}} = \text{t}_{\text{f}} = 6 \text{ ns})$

Symbol	Parameter	Conditions	Тур.	Guaranteed Limit	Unit
t _{PHL} , t _{PLH}	Maximum Propagation Delay		8	15	ns

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

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AC ELECTRICAL CHARACTERISTICS

(V_{CC} = 2.0 V to 6.0 V, C_L = 50 pF, t_r = t_f = 6 ns, unless otherwise specified)

				T _A =	25°C	T _A = −40°C to 85°C	T _A = −55°C to 125°C	
Symbol	Parameter	V _{CC} (V)	Conditions	Тур.		Guaranteed L	imits	Unit
t _{PHL} , t _{PLH}	Maximum Propagation	2.0		45	90	113	134	ns
	Delay	4.5		9	18	23	27	
		6.0		8	15	19	23	
t _{TLH} , t _{THL}	LH, t _{THL} Maximum Output Rise and Fall Time	2.0		30	75	95	110	ns
		4.5		8	15	19	22	
		6.0		7	13	16	19	
C _{PD}	Power Dissipation Capacitance (Note 3)		(per gate)	20	-	-	-	pF
C _{IN}	Maximum Input Capacitance			5	10	10	10	pF

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions. 3. C_{PD} determines the no load dynamic power consumption, $P_D = C_{PD} V_{CC}^2 f + I_{CC} V_{CC}$, and the no load dynamic current consumption,

 $I_{\rm S} = C_{\rm PD} V_{\rm CC} f + I_{\rm CC}.$

ORDERING INFORMATION

Device	Marking	Package	Shipping [†]
MM74HC02M	HC02A	SOIC-14 NB	55 Units / Tube
MM74HC02MX	HC02A	 (Pb-Free and Halide Free) 	2500 / Tape & Reel
MM74HC02MTC	HC 02A	TSSOP-14 (Pb-Free and Halide Free)	96 Units / Tube
MM74HC02MTCX	HC 02A		2500 / Tape & Reel

†For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

NOTE: All packages are lead free per JEDEC: J-STD-020B standard.

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*For additional information on our Pb–Free strategy and soldering details, please download the **onsemi** Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

STYLES ON PAGE 2

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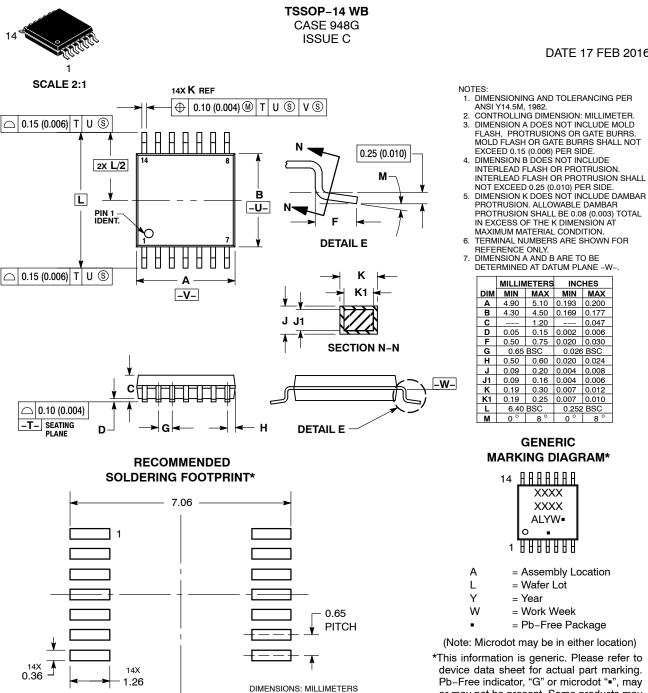
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*For additional information on our Pb-Free strategy and soldering details, please download the onsemi Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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- FLASH, PROTRUSIONS OR GATE BURRS. MOLD FLASH OR GATE BURRS SHALL NOT

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